# Complementary Bias Resistor Transistors R1 = 47 k $\Omega$ , R2 = 22 k $\Omega$

## NPN and PNP Transistors with Monolithic Bias Resistor Network

This series of digital transistors is designed to replace a single device and its external resistor bias network. The Bias Resistor Transistor (BRT) contains a single transistor with a monolithic bias network consisting of two resistors; a series base resistor and a base-emitter resistor. The BRT eliminates these individual components by integrating them into a single device. The use of a BRT can reduce both system cost and board space.

#### **Features**

- Simplifies Circuit Design
- Reduces Board Space
- Reduces Component Count
- S and NSV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- This Device is Pb-Free, Halogen Free/BFR Free and is RoHS Compliant

#### **MAXIMUM RATINGS**

(T<sub>A</sub> = 25°C both polarities Q<sub>1</sub> (PNP) & Q<sub>2</sub> (NPN), unless otherwise noted)

Rating	Symbol	Max	Unit
Collector-Base Voltage	$\mathcal{V}_{CBO}$	50	Vdc
Collector-Emitter Voltage	$V_{CEO}$	50	Vdc
Collector Current - Continuous	1 <sub>C</sub>	100	mAdc
Input Forward Voltage	V <sub>IN(fwd)</sub>	40	Vdc
Input Reverse Voltage	V <sub>IN(rev)</sub>	10	Vdc

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

#### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
NSBC144WPDP6T5G	SOT-963	8,000/Tape & Reel

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

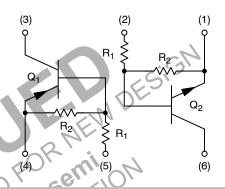
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#### **PIN CONNECTIONS**



#### MARKING DIAGRAMS



SOT-963 CASE 527AD



T = Specific Device Code M = Date Code\*

<sup>\*</sup>Date Code orientation may vary depending upon manufacturing location.

#### THERMAL CHARACTERISTICS

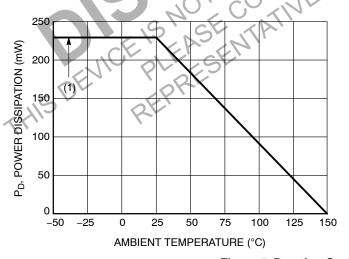
NSBC144WPDP6 (SOT-963)	Characteristic	Symbol	Max	Unit
Total Davisa Dissination	ONE JUNCTION HEATED			
Total Device Dissipation $T_A = 25^{\circ}C \qquad (Note 1)$ $(Note 2)$ Derate above 25°C $(Note 2)$	(Note 1)	P <sub>D</sub>	231 269 1.9 2.2	MW mW/°C
Thermal Resistance, Junction to Ambient (Note 2)	(Note 1)	$R_{ heta JA}$	540 464	°C/W
NSBC144WPDP6 (SOT-963)	BOTH JUNCTION HEATED (Note 3)	•		
Total Device Dissipation $T_A = 25^{\circ}C \qquad \text{(Note 1)}$ $\text{(Note 2)}$ Derate above 25°C $\text{(Note 2)}$	(Note 1)	P <sub>D</sub>	339 408 2.7 3.3	MW mW/°C
Thermal Resistance, Junction to Ambient (Note 2)	(Note 1)	$R_{\theta JA}$ $T_{J}, T_{stg}$	369 306	CL,c/M
	per traces, still air. assume total power is sum of two equally powered chan	hels. Porsen	ni ATION	

- 1. FR-4 @ 100 mm<sup>2</sup>, 1 oz. copper traces, still air. 2. FR-4 @ 500 mm<sup>2</sup>, 1 oz. copper traces, still air.
- 3. Both junction heated values assume total power is sum of two equally powered channels.

**ELECTRICAL CHARACTERISTICS** (T<sub>A</sub> = 25°C both polarities Q<sub>1</sub> (PNP) & Q<sub>2</sub> (NPN), unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS					
Collector-Base Cutoff Current (V <sub>CB</sub> = 50 V, I <sub>E</sub> = 0)	I <sub>CBO</sub>	-	-	100	nAdc
Collector-Emitter Cutoff Current $(V_{CE} = 50 \text{ V}, I_B = 0)$	I <sub>CEO</sub>	-	-	500	nAdc
Emitter-Base Cutoff Current (V <sub>EB</sub> = 6.0 V, I <sub>C</sub> = 0)	I <sub>EBO</sub>	-	-	0.13	mAdc
Collector-Base Breakdown Voltage $(I_C = 10 \mu A, I_E = 0)$	V <sub>(BR)CBO</sub>	50	-	-	Vdc
Collector-Emitter Breakdown Voltage (Note 4) (I <sub>C</sub> = 2.0 mA, I <sub>B</sub> = 0)	V <sub>(BR)CEO</sub>	50	-	-	Vdc
ON CHARACTERISTICS					
DC Current Gain (Note 4) (I <sub>C</sub> = 5.0 mA, V <sub>CE</sub> = 10 V)	h <sub>FE</sub>	80	140	-	7
Collector-Emitter Saturation Voltage (Note 4) (I <sub>C</sub> = 10 mA, I <sub>B</sub> = 0.3 mA)	V <sub>CE(sat)</sub>	-		0.25	V
Input Voltage (Off) $(V_{CE} = 5.0 \text{ V, } I_{C} = 100 \mu\text{A}) \text{ (NPN)} $ $(V_{CE} = 5.0 \text{ V, } I_{C} = 100 \mu\text{A}) \text{ (PNP)}$	V <sub>i(off)</sub>		1.7		Vdc
Input Voltage (On) (V <sub>CE</sub> = 0.2 V, I <sub>C</sub> = 3.0 mA) (NPN) (V <sub>CE</sub> = 0.2 V, I <sub>C</sub> = 3.0 mA) (PNP)	V <sub>i(on)</sub>	FOR	2.6 2.7	N-	Vdc
Output Voltage (On) ( $V_{CC}$ = 5.0 V, $V_{B}$ = 4.0 V, $R_{L}$ = 1.0 k $\Omega$ )	V <sub>OL</sub>	.D-00°	ATI	0.2	Vdc
Output Voltage (Off) ( $V_{CC} = 5.0 \text{ V}, V_B = 0.5 \text{ V}, R_L = 1.0 \text{ k}\Omega$ )	VOH	4.9	5///	-	Vdc
Input Resistor	Rî	32.9	47	61.1	kΩ
Resistor Ratio	R <sub>1</sub> /R <sub>2</sub>	1.7	2.1	2.6	

<sup>4.</sup> Pulsed Condition: Pulse Width = 300 ms, Duty Cycle ≤ 2%



(1) SOT-963; 100 mm<sup>2</sup>, 1 oz. Copper Trace

Figure 1. Derating Curve

## TYPICAL CHARACTERISTICS – NPN TRANSISTOR NSBC144WPDP6

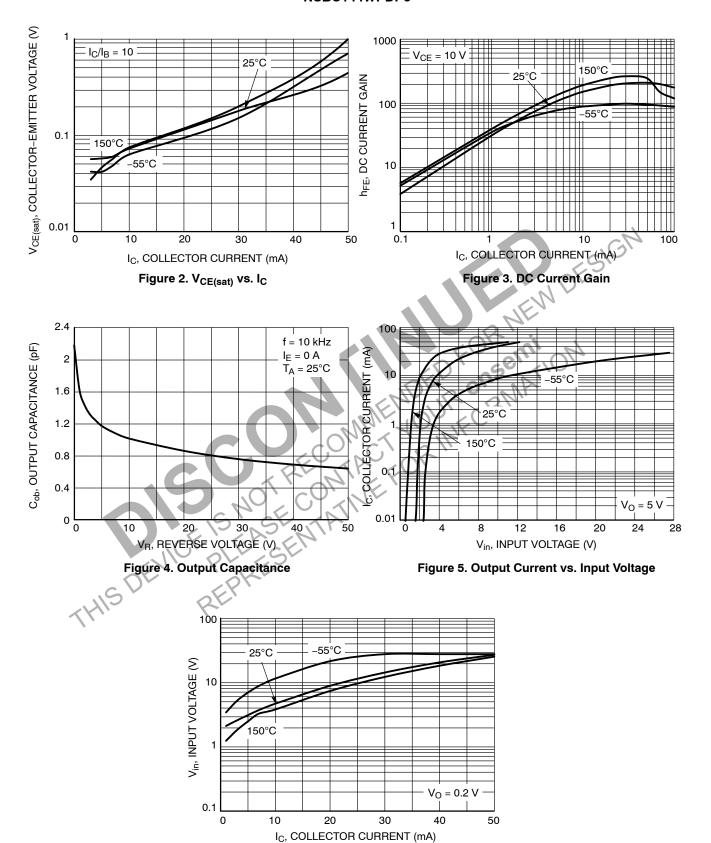
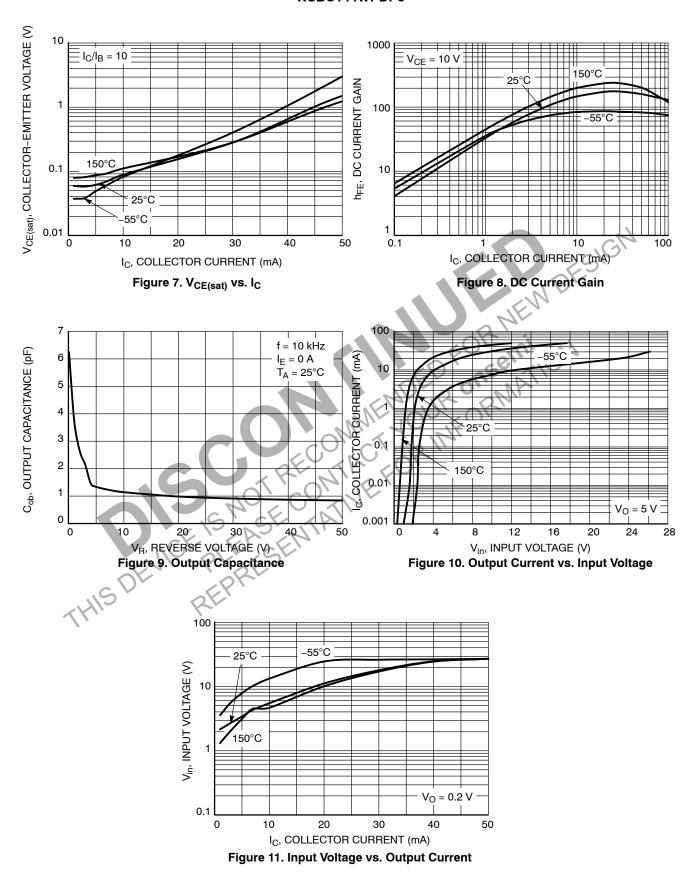


Figure 6. Input Voltage vs. Output Current

## TYPICAL CHARACTERISTICS – PNP TRANSISTOR NSBC144WPDP6





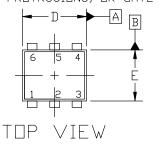


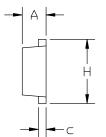
#### SOT-963 1.00x1.00x0.37, 0.35P CASE 527AD ISSUE F

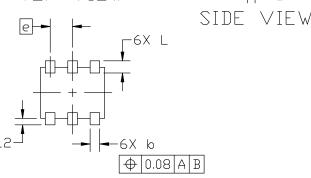
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#### NOTES:

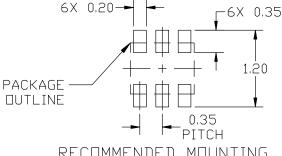
- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2018.
- 2. CONTROLLING DIMENSION: MILLIMETERS.
- 3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS, MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
- 4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.







#### MILLIMETERS DIM MIN. N□M. MAX. Α 0.34 0.37 0.40 b 0.10 0.15 0.20 0.17 $\subset$ 0.07 0.12 D 0.95 1.00 1.05 Ε 0.75 0.80 0.85 0.35 BSC 6 Н 1.00 1.05 0.95 1 0.19 REF L2 0.05 0.10 0.15



## RECOMMENDED MOUNTING FOOTPRINT

\*For additional information on our Pb-Free strategy and soldering details, please download the DN Semiconductor Soldering and Mounting Techniques Reference manual, SDLDERRM/D.

#### BOTTOM VIEW

PIN 1. COLLECTOR 2. COLLECTOR

3. BASE 4. EMITTER

STYLE 7: PIN 1. CATHODE 2. ANODE

3. CATHODE 4. CATHODE

5. ANODE 6. CATHODE

STYLE 10: PIN 1. CATHODE 1 2. N/C 3. CATHODE 2

4. ANODE 2 5. N/C

6. ANODE 1

5. COLLECTOR 6. COLLECTOR

STYLE 1:	STYLE 2:
PIN 1. EMITTER 1	PIN 1. EMITTER 1
2. BASE 1	2. EMITTER2
3. COLLECTOR 2	3. BASE 2
4. EMITTER 2	4. COLLECTOR 2
5. BASE 2	5. BASE 1
6. COLLECTOR 1	6. COLLECTOR 1
STVI F 4:	STYLE 5:

PIN 1. 2.

3. 4.

5.

2. CATHODE 1	
<ol><li>ANODE/ANODE 2</li></ol>	2
<ol><li>CATHODE 2</li></ol>	
<ol><li>CATHODE 2</li></ol>	
<ol><li>6. ANODE/ANODE 1</li></ol>	
STYLE 6:	
PIN 1. CATHODE	
2 ANODE	

STYLE 3: PIN 1. CATHODE 1

5:	STYLE 6:
CATHODE	PIN 1. CATHODE
CATHODE	2. ANODE
ANODE	<ol><li>CATHODE</li></ol>
ANODE	4. CATHODE
CATHODE	5. CATHODE
CATHODE	6. CATHODE

6. CATHODE	6. CATHODE
YLE 8:	STYLE 9:
PIN 1. DRAIN	PIN 1. SOURCE 1
2. DRAIN	2. GATE 1
3. GATE	3. DRAIN 2
4. SOURCE	4. SOURCE 2
5. DRAIN	5. GATE 2
6. DRAIN	6. DRAIN 1

### GENERIC MARKING DIAGRAM\*



XX = Specific Device CodeM = Month Code

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

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DESCRIPTION:	SOT-963 1.00x1.00x0.37, 0.35P		PAGE 1 OF 1	

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